BL040

mATX *chassis*

Features

New Partition Plate Cooling Technology (PPCT)

PPCT is the world's first advanced thermal and acoustic cooling technology. It provides SFF chassis excellent thermal solutions while creating a quieter computing experience. The second generation of PPCT includes a removable air duct and an enlarged adjustable vent for various positions within your PC. The New Partition Plate Cooling Technology also supports the LGA1155 socket.

Detachable Drive Cage

For easy installation.

Tool Free

Optional screwless designs-ODD/FDD/HDD bays, expansion slots, and top cover.

High Compatibility

It is compatible with standard desktop components, which makes the installation easier and provides a great expandability when needed.

Design Philosophy

A small 11.5L SFF chassis with optimal thermal and acoustic performance without additional system fan.

Multi-Enjoyment

Designated Infrared Receiver position to support Media Center and optional Internal amplifier.

Specification

CASE SIZE	S.F.F Slim Chassis
PROCESSOR	Support Dual Core and Quad Core Processor
EXTERNAL DRIVE BAY	5.25" x 1, 3.5" x1
INTERNAL DRIVE BAY	3.5" x 2, 2.5" x 1
FRONT PORTS	USB 2.0 x 4, HD Audio
DIMENSIONS (HxWxD)	13" x 3.8" x 14.4"
w/o Front Panel	330 x 96 x 365 mm (11.5L)
M/B	Micro ATX
I/O EXPANSION SLOTS	Low Profile Slots x 4
POWER SUPPLY	Standard TFX 12V
THERMAL SOLUTION	•Removable Ai Filter •80mm Side Fan
SAFETY	Meets RoHS, CE and FCC Class B Requirements
SECURITY	Padlock Loop / Kensington Slot
OPTIONAL	•USB 3.0 x 2 •3.5" to 2.5" HDD/SSD Bracket •Intel Lanyu Ref. Design-New Partition Plate Cooling Tech (New PPCT) •IEEE 1394 •IR •Chassis Intrusion Switch •Tool-Free ODD/FDD/HDD Bays Clips •Tool-Free Expansion Slots Clip •Tool-FreeTop Cover Clips

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